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N-Channel PowerTrench[®] MOSFET 60 V, 42 A, 7.4 m Ω

Features

- Max $r_{DS(on)}$ = 7.4 m Ω at V_{GS} = 10 V, I_D = 14 A
- Max $r_{DS(on)}$ = 10.3 m Ω at V_{GS} = 8 V, I_D = 12.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

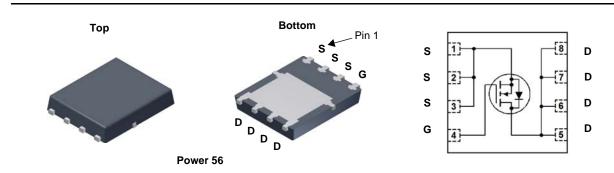


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary DC-DC Switch
- Motor Bridge Switch
- Synchronous Rectifier



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame	Ratings	Units			
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		42		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	14	Α	
	-Pulsed			80		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	86	mJ	
D	Power Dissipation	T _C = 25 °C		69	14/	
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case		1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86520	FDMS86520	Power 56	13 "	12 mm	3000 units

October 2014

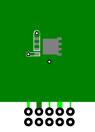
⁼ DMS86520
N-Channel P
owerTrench [®]
[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		30		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.5	3.6	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-11		mV/°C
		V _{GS} = 10 V, I _D = 14 A		6.0	7.4	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 12.5 A		7.3	10.3	mΩ
- (-)		V_{GS} = 10 V, I _D = 14 A, T _J = 125 °C		9	11	
	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 14 \text{ A}$		49		S
9fs						
-	Characteristics			2140	2850	pF
Dynamic C _{iss}	Characteristics			I	2850 830	1
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance			2140		pF
Dynamic C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance		0.1	2140 624	830	pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance		0.1	2140 624 24	830 40	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	2140 624 24	830 40	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics		0.1	2140 624 24 0.7	830 40 2.1	pF pF pF Ω
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz	0.1	2140 624 24 0.7	830 40 2.1 31	pF pF pF Ω ns
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_d(off)$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 14 \text{ A},$	0.1	2140 624 24 0.7 17 6.7	830 40 2.1 31 14	pF pF pF Ω ns
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	0.1	2140 624 24 0.7 17 6.7 20	830 40 2.1 31 14 32	pF pF pF Ω ns ns
$\begin{array}{c} \textbf{Dynamic} \\ \hline \textbf{C}_{iss} \\ \hline \textbf{C}_{rss} \\ \hline \textbf{C}_{rss} \\ \hline \textbf{R}_{g} \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Q}_{g} \\ \end{array}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 30 \text{ V},$	0.1	2140 624 24 0.7 17 6.7 20 4	830 40 2.1 31 14 32 10	pF pF Ω ns ns ns ns
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	0.1	2140 624 24 0.7 17 6.7 20 4 28	830 40 2.1 31 14 32 10 40	pF pF pF Ω ns ns ns ns ns

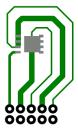
Electrical Characteristics T_J = 25 °C unless otherwise noted

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$	(Note 2)	0.74	1.2	V
		V _{GS} = 0 V, I _S = 14 A	(Note 2)	0.83	1.3	v
t _{rr}	Reverse Recovery Time	I _F = 14 A, di/dt = 100 A/μs		37	60	ns
Q _{rr}	Reverse Recovery Charge			21	35	nC
t _{rr}	Reverse Recovery Time	I _F = 14 A, di/dt = 300 A/μs –		31	49	ns
Q _{rr}	Reverse Recovery Charge			40	64	nC

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



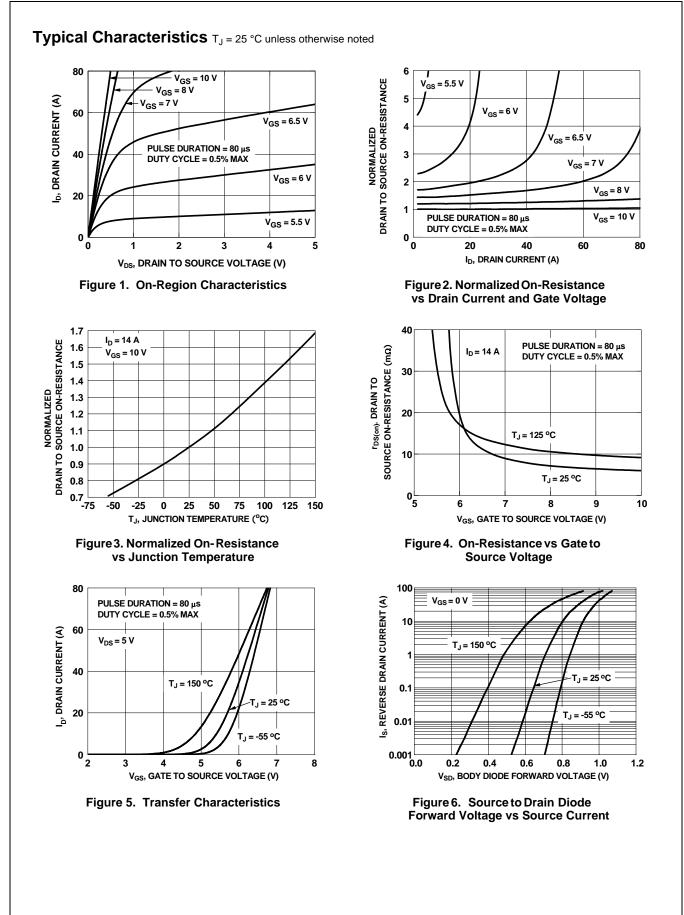
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper



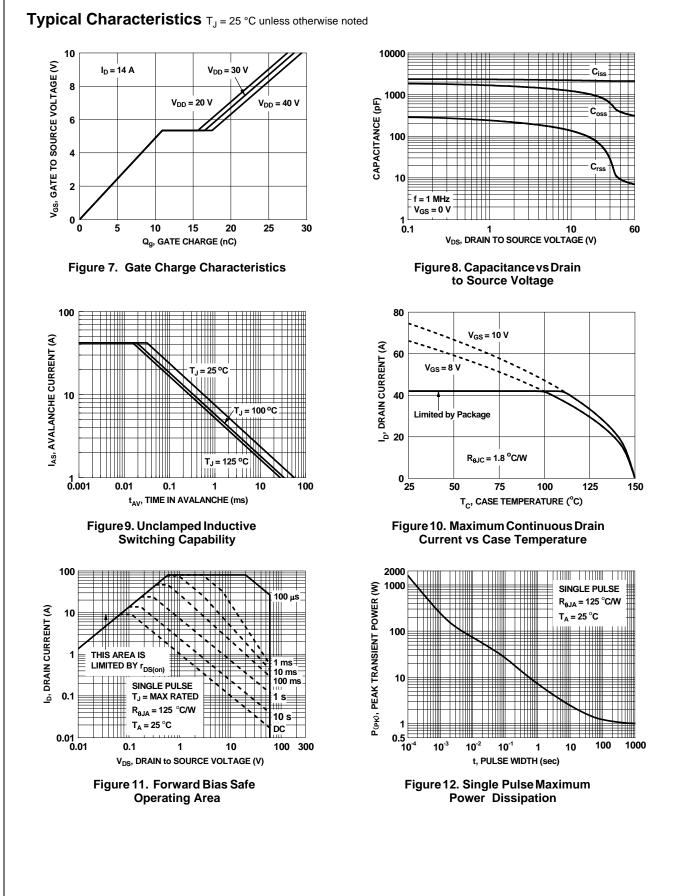
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

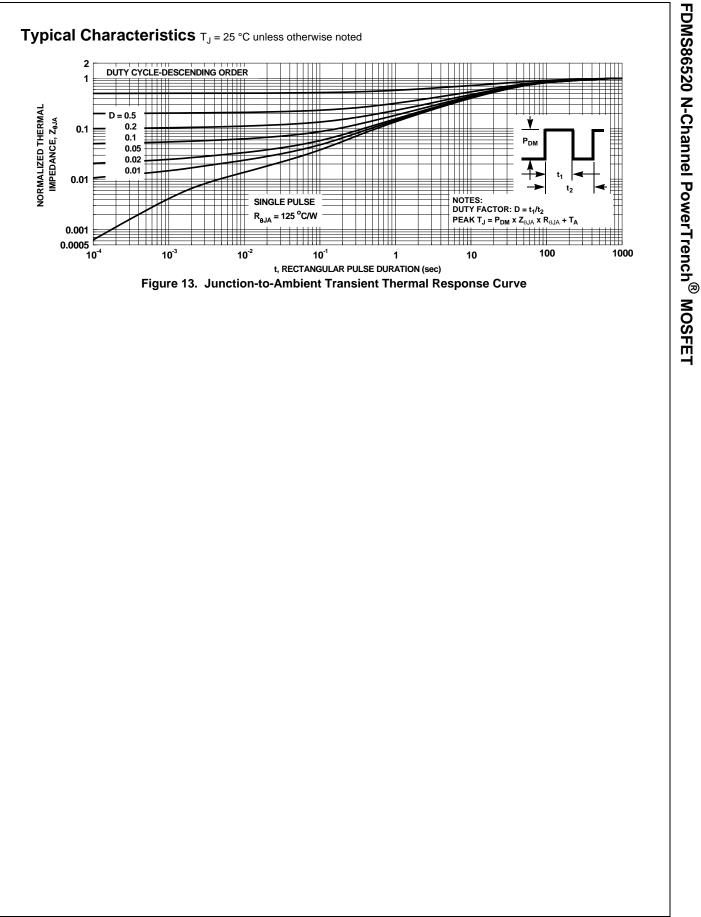
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 86 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 24 A, V_{DD} = 54 V, V_{GS} = 10 V.

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